

# MHF® 5 Connector

Part No. Plug: 20711-001R-81 Receptacle: 20566-001E-01

# **Product Specification**

Qualification Test Report No. TR-15062

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2	S21133	March 22, 2021	N.Miyashiro	K.Ikeshita	M.Takemoto
1	S18475	August 8, 2018	M.Nomoto	K.Yufu	K.Yotsutani
0	S15358	August 21, 2015	T.Yayoshi	K.Yotsutani	E.Kawabe
Rev.	ECN	Date	Prepared by	Checked by	Approved by

#### 1. Scope

This product specification defines the test conditions and the performances of the MHF 5 Connector AWG#36 φ0.81 Cable.

#### 2. Product Name and Parts No.

#### 2.1 Product Name

MHF 5 PLUG

MHF 5 RECEPTACLE

#### 2.2 Parts No.

Plug: 20711-001R-81 Receptacle: 20566-001E-01

#### 3. Rating

#### 3.1 Applicable Cable

#### (1) Description

Inner conductor: AWG#36(7/0.05) ,Silver plating annealed copper wire

Dielectric core: Fluoro-plastics ,diameter 0.4(+0.04,-0.02)mm , nominal thickness 0.125mm

Outer conductor: Nominal diameter 0.65mm, silver plating annealed copper wire or tin plating annealed copper wire

Jacket: Fluoro-plastics, diameter 0.81(+0.04,-0.02)mm, nominal thickness 0.08mm

#### (2) Requirements

Characteristic impedance: 50(+3,-3)ohm by TDR method

Nominal capacitance (Reference value): 96 pF/m

Conductor resistance of inner conductor at 293K (20°C): 1400 ohm/km MAX.

Insulation resistance: 1000 mega-ohm • km MIN.

Dielectric withstand voltage: no breakdown at AC1000V for 1 minutes.

#### 3.2 Operating Conditions

Voltage: 60 Vr.m.s AC

Operating Temperature:  $233 \sim 363 \text{K}(-40 \degree \text{C} \sim +90 \degree \text{C})$ 

(Containing temperature rise by current)

Nominal characteristic impedance: 50Ω

Frequency: DC~12 GHz

VSWR: [Plug] 1.3 MAX at 0.1~3 GHz 1.5 MAX at 3~6 GHz

1.6 MAX at 6~9 GHz

1.7 MAX at 9~12 GHz

[Receptacle] 1.3 MAX at 0.1~3 GHz

1.4 MAX at 3~6 GHz

1.5 MAX at 6~9 GHz

1.5 MAX at 9~12 GHz

#### 3.3 Storage Conditions

Storage temperature: 248 to 333K(-25°C to 60°C) Storage humidity: 85% max. (Non-condensing)

#### 4. Test and Performance

#### **Test Condition**

Unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202.

Temperature: 288K to 308K(15°C to 35°C)

Pressure: 866hPa to 1066hPa(650mmHg to 800mmHg)

Relative humidity: 45 to 75% R.H.

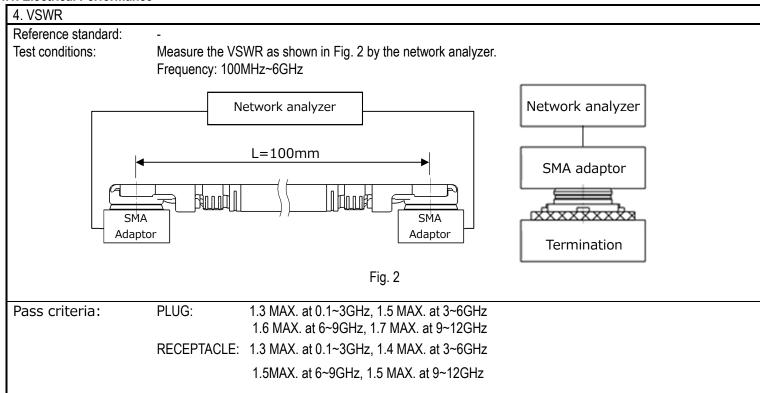
# 4.1. Electrical Performance

1. Contact Resistance	
Reference standard:	MIL-STD-202-307
Test conditions:	Solder the receptacle connector to the test board and mate the plug connector together, then measure the contact resistance as shown in Fig. 1 by the four terminal methods. Apply the low level condition. Open circuit voltage: 20mV MAX.  Circuit current: 10mA MAX.
	Main contact = A-B  Ground contact
	Fig.1
Pass criteria:	Inner contact Initial: $20m\Omega$ MAX. After testing: $\triangle$ R20m $\Omega$ MAX. Ground contact Initial: $20m\Omega$ MAX. After testing: $\triangle$ R100m $\Omega$ MAX.

2. Insulation Resistance	
Reference standard:	MIL-STD-202-302
Test conditions:	Mate the plug and receptacle connector together, and then apply DC 100 V between the inner contact and the ground contact.
Pass criteria:	Initial: 500 MΩ MIN. After testing: 100 MΩ MIN.

3. D. W. Voltage	
Reference standard:	MIL-STD-202-301
Test conditions:	Mate the plug and receptacle connector together, then apply AC 200V(rms) between the inner contact and the ground contact for a minute.
Pass criteria:	No abnormalities such as creeping discharge, flashover, insulator breakdown occur.

#### 4.1. Electrical Performance



# 4.2. Mechanical Performance

<ol> <li>Unmating force</li> </ol>	
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then place the board and plug on push-on/pull-off machine, measure of initial and un-mating 30 cycles at a speed 25±3mm/min. along the mating axis.
Pass criteria:	Initial: 4 N MIN. After 30cycles: 2 N MIN.

2. Durability	
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then place the board and plug on the push-on/pull-off machine, and repeat mating and un-mating 30cycles at a speed 25±3mm/min. along the mating axis.
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

3. Crimp Strength	
Reference standard:	-
Test conditions:	Pull the cable as shown in Fig-3 at speed of 25±3mm/minutes by the tensile strength machine and measure the retention force.
	Fig. 3
Pass criteria:	7N MIN.

# 4.2. Mechanical Performance

4. Cable Retention Force	е
Reference standard:	-
Test conditions:	Apply force to the cable as shown in Fig. 4.  During the testing, run 100mA DC to check electrical discontinuity.
	Prohibited
	→ 2N MAX.
	↓ Prohibited
	Fig. 4
Pass criteria:	Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.  Appearance: Looseness between the parts, chipping, breakage or other abnormality shall not occur.

5. Vibration	
Reference standard:	-
Test conditions:	Apply the following vibration to the mating connector. During the testing, run 100mA DC to check electrical discontinuity.
	Frequency: 10Hz → 10Hz → 10Hz / approx. 15 minutes.
	Half amplitude, Peak value of acceleration: 1.5mm or 59m/s2 (6G)
	Directions, cycle: 3 mutually perpendicular direction
	5 cycles (approx. 75min) about each direction
Pass criteria:	Contact resistance: Shall meet 4.1.1.
	Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.
	Appearance: No abnormality adversely affecting the performance shall occur

6. Shock	
Reference standard:	MIL-STD-202-213, Test condition B.
Test conditions:	Apply the following vibration to the mating connector. During the testing, run 100mA DC to check electrical discontinuity.  Peak value of acceleration: 735m/s2 (75G)  Duration: 11msec
	Wave Form: half sinusoidal Directions, cycle: 6 mutually perpendicular direction, 3 cycles about each direction
Pass criteria:	Contact resistance: Shall meet 4.1.1.  Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.  Appearance: No abnormality adversely affecting the performance shall occur

# 4.3. Environmental Performance

1. Humidity (Steady state)	
Reference standard:	MIL-STD-202-103, Test condition B.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment.  Temperature: 313±2K (40±2°C)  Humidity: 90~95%RH  Duration: 96 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3. Appearance: No abnormality adversely affecting the performance shall occur

2. Thermal Shock	
Reference standard:	MIL-STD-202-107, Test condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment.  Temperature: 218K(-55°C),30min.→358K(85°C),30min.  Transition time: 5min. MAX.  Cycle: 5 cycles
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3. Appearance: No abnormality adversely affecting the performance shall occur

3. High Temperature Life	
Reference standard:	-
Test conditions:	Apply the following environment to the mating connector.  Temperature: 363±2K (90±2℃)  Duration: 96 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur

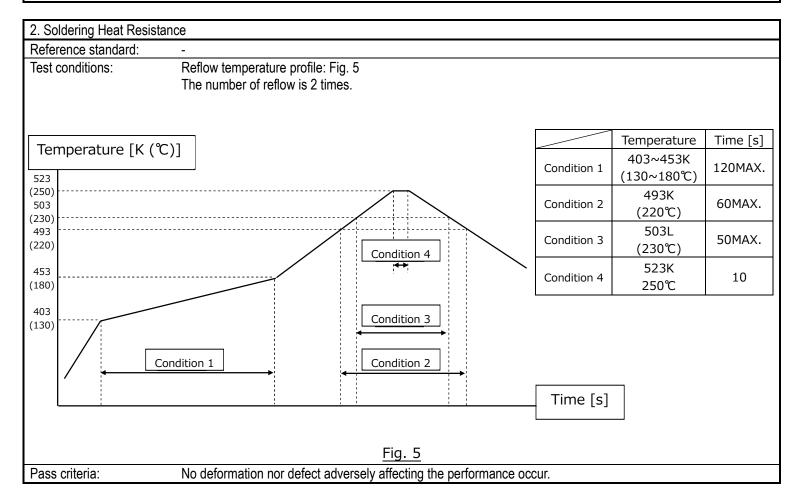
4. H₂S Gas							
Reference standard:	-						
Test conditions:	Apply the following environment to the mating connector.						
	Temperature: 313±2K (40±2°C)						
	Relative Humidity: 80±5%RH						
	Gas: H2S 3±1ppm						
	Duration: 96 hours						
Pass criteria:	Contact resistance: Shall meet 4.1.1.						
	Appearance: No abnormality adversely affecting the performance shall occur						

### 4.3. Environmental Performance

5. Salt Water Spray	
Reference standard:	MIL-STD-202-101, Test condition B.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment.  Temperature: 308±2K (35±2°C)  Saltwater density: 5±1% [by weight]  Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur

#### 4.4. Others

1. Solder ability	
Reference standard:	MIL-STD-202-208
Test conditions:	Immerse the contact soldering part to flux of RMA or R type for 5 to 10 seconds, then dip the part into the solder bath of $518\pm5$ K ( $245\pm5$ °C) for $5\pm0.5$ seconds.
Pass criteria:	More than 95% of the dipped surface becomes wet and the pinhole that should not gather at one point is less than 5%.



# 4.5 Test Sequence and Specimen Quantity

**Table.1 Test Sequence and Sample Quantity** 

Took Marin	Group													
Test Item	Α	В	С	D	Е	F	G	Н	J	K	L	М	N	Р
Contact Resistance			1, 3			1, 3	1, 3	1, 5	1, 5	1, 3	1, 3	1, 3		
Insulation Resistance								2, 6	2, 6					
D. W. Voltage								3, 7	3, 7					
VSWR	1													
Unmating force	1	1												
Durability			2											
Crimp Strength				1										
Cable Retention Force					1									
Vibration						2								
Shock							2							
Humidity (Steady State)								4						
Thermal Shock									4					
High Temperature Life										2				
H2S Gas											2			
Salt Water Spray												2		
Solder ability													1	
Soldering Heat Resistance														1
Specimen quantity	10	10	10	10	10	10	10	10	10	10	10	10	10	10

Numbers indicate sequence in which tests are performed.

# 5. Recommended Metal Mask

Refer to drawing for the recommended metal mask thickness and opening dimension